

## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

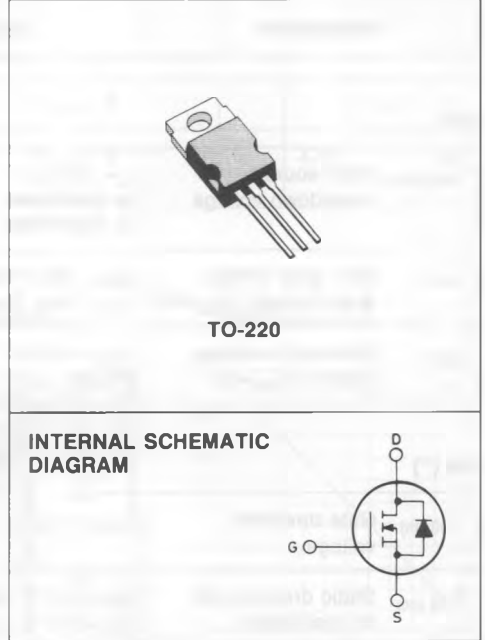
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
SGSP364	450 V	1.5 Ω	5 A
SGSP369	500 V	1.5 Ω	5 A

- HIGH SPEED SWITCHING APPLICATIONS
- HIGH VOLTAGE - FOR ELECTRONIC LAMP BALLAST
- ULTRA FAST SWITCHING
- EASY DRIVE - REDUCED COST AND SIZE

### INDUSTRIAL APPLICATIONS:

- ELECTRONIC LAMP BALLAST
- DC SWITCH

N - channel enhancement mode POWER MOS field effect transistors. Easy drive and very fast switching times make these POWER MOS transistors ideal for high speed switching applications. Applications include DC switch, constant current source, ultrasonic equipment and electronic ballast for fluorescent lamps.



### ABSOLUTE MAXIMUM RATINGS

	SGSP364	SGSP369	
V <sub>DS</sub>	450	500	V
V <sub>DGR</sub>	450	500	V
V <sub>GS</sub>		± 20	V
I <sub>D</sub>	5		A
I <sub>D</sub>	3		A
I <sub>DM</sub> (*)	20		A
I <sub>DLM</sub> (*)	20		A
P <sub>tot</sub>	100		W
	Derating factor	0.8	W/°C
T <sub>sig</sub>	- 65 to 150		°C
T <sub>j</sub>	150		°C

(\*) Pulse width limited by safe operating area

**THERMAL DATA**

$R_{thj-case}$	Thermal resistance junction-case	max	1.25	°C/W
$T_L$	Maximum lead temperature for soldering purpose		275	°C

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^\circ\text{C}$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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**OFF**

$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}$ for <b>SGSP364</b> for <b>SGSP369</b>	$V_{GS} = 0$	450 500		V V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$	$T_c = 125^\circ\text{C}$		250 1000	$\mu\text{A}$ $\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA

**ON (\*)**

$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu\text{A}$	2		4	V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}$ $V_{GS} = 10 \text{ V}$	$I_D = 2.5 \text{ A}$ $I_D = 2.5 \text{ A}$			1.5 3	$\Omega$ $\Omega$

**DYNAMIC**

$g_{fs}$	Forward transconductance	$V_{DS} = 25 \text{ V}$	$I_D = 2.5 \text{ A}$	3			mho	
$C_{iss}$	Input capacitance	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$	$f = 1 \text{ MHz}$		780	1000	pF	
$C_{oss}$	Output capacitance					200		pF
$C_{rss}$	Reverse transfer capacitance					130		pF

**SWITCHING**

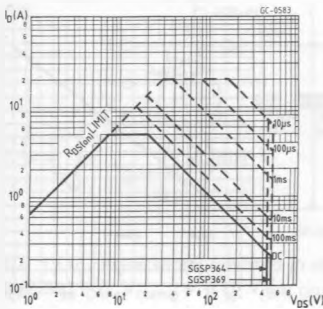
$t_d(on)$	Turn-on time	$V_{DD} = 250 \text{ V}$	$I_D = 2.5 \text{ A}$		20	30	ns
$t_r$	Rise time	$V_i = 10 \text{ V}$	$R_i = 4.7 \Omega$		30	40	ns
$t_d(off)$	Turn-off delay time	(see test circuit)			85	110	ns
$t_f$	Fall time				25	35	ns

ELECTRICAL CHARACTERISTICS (Continued)

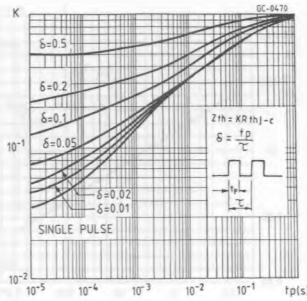
Parameters	Test Conditions	Min.	Typ.	Max.	Unit
$I_{SD}$ $I_{SDM}$ (*)	Source-drain current Source-drain current (pulsed)			5 20	A A
$V_{SD}$	Forward on voltage	$I_{SD} = 5\text{ A}$	$V_{GS} = 0$	1.2	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 5\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$	$V_{GS} = 0$	470	ns

(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%  
 (\*) Pulse width limited by safe operating area

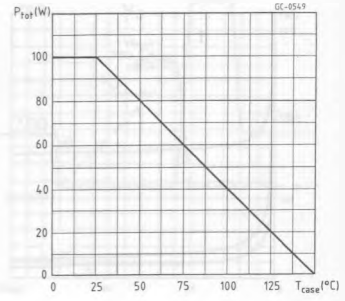
Safe operating areas



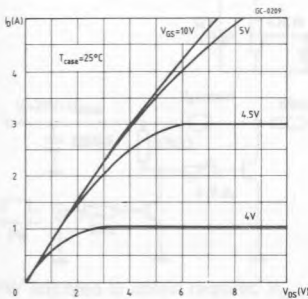
Thermal impedance



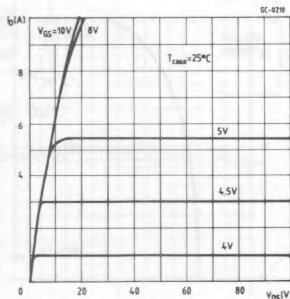
Derating curve



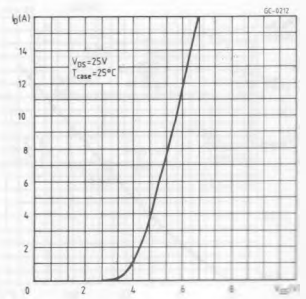
Output characteristics



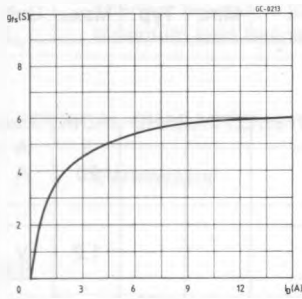
Output characteristics



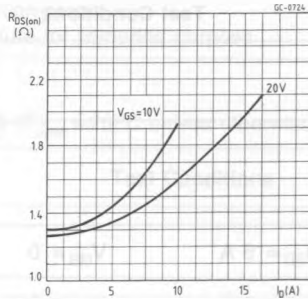
Transfer characteristics



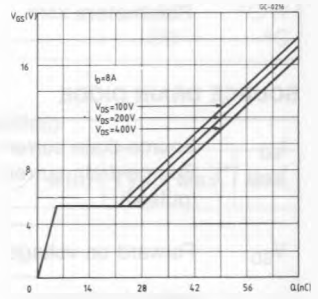
Transconductance



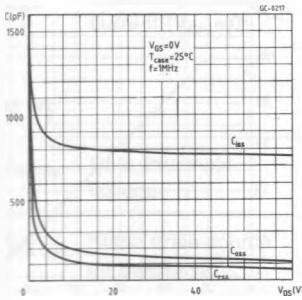
Static drain-source on resistance



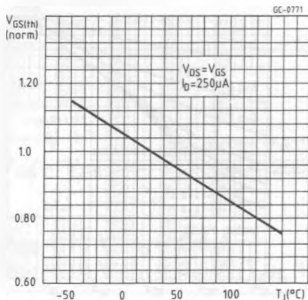
Gate charge vs gate-source voltage



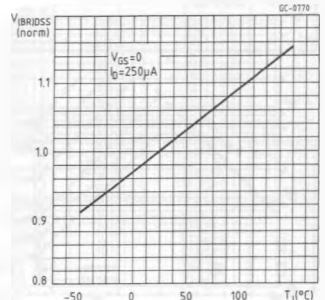
Capacitance variation



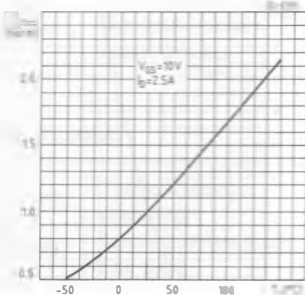
Normalized gate threshold voltage vs temperature



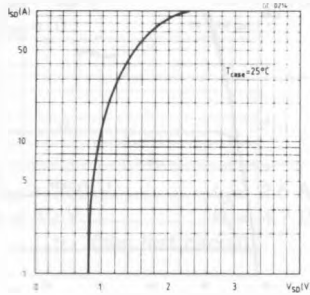
Normalized breakdown voltage vs temperature



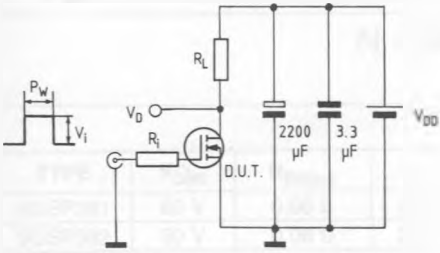
Normalized on resistance vs temperature



Source-drain diode forward characteristics



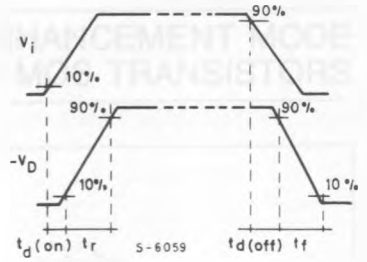
Switching times test circuit for resistive load



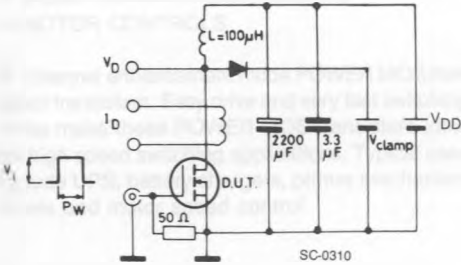
Pulse width  $\leq 100 \mu\text{s}$   
Duty cycle  $\leq 2\%$

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Switching time waveforms for resistive load



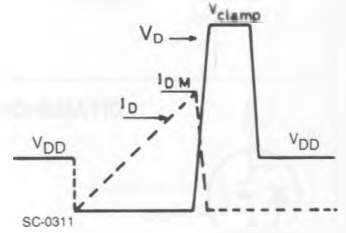
Clamped inductive load test circuit



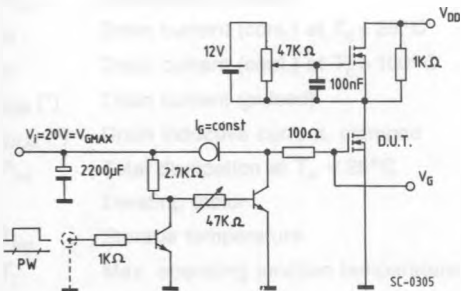
$V_i = 12 \text{ V}$  - Pulse width: adjusted to obtain specified  $I_{DM}$ .  $V_{clamp} = 0.75 V_{(BR)}$  DSS

SC-0310

Clamped inductive waveforms



Gate charge test circuit



PW adjusted to obtain required  $V_G$

Body-drain diode  $t_{rr}$  measurement  
Jedec test circuit

